MD® MEDICAL DEVICE ADHESIVES
1-CN007 Product Data Sheet

1-CN007
UV/Visible Light-Curable Adhesive for Bonding Plastics and Metal

APPLICATIONS
- Tube Sets & Fittings
- Reservoirs
- Needle Bonding

FEATURES
- UV/Visible Light Cure
- Moisture Resistant

RECOMMENDED SUBSTRATES
- PC
- PVC
- PMMA
- PU
- ABS
- Stainless Steel

BIOCOMPATIBILITY
- ISO 10993-5 Cytotoxicity

Dymax MD® Medical Device Adhesive 1-CN007 is designed for fast bonding of metals and plastics typically used in the manufacture of medical devices. Dymax MD® Medical Device adhesives are solvent free and cure upon exposure to UV and visible light between 300-500 nm. Their ability to cure in seconds enables faster processing, greater output, and lower processing costs. When cured with Dymax light-curing spot lamps, focused-beam lamps, or flood lamps, they deliver optimum speed and performance for medical device assembly. Dymax lamps offer the optimum balance of UV and visible light for the fastest, deepest cures. This product is in full compliance with RoHS directives 2015/863/EU.

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**UNCURED PROPERTIES**

<table>
<thead>
<tr>
<th>Property</th>
<th>Value</th>
<th>Test Method</th>
</tr>
</thead>
<tbody>
<tr>
<td>Solvent Content</td>
<td>No Nonreactive Solvents</td>
<td>N/A</td>
</tr>
<tr>
<td>Chemical Class</td>
<td>Acrylated Urethane</td>
<td>N/A</td>
</tr>
<tr>
<td>Appearance</td>
<td>Clear Transparent Liquid</td>
<td>N/A</td>
</tr>
<tr>
<td>Soluble in</td>
<td>Organic Solvents</td>
<td>N/A</td>
</tr>
<tr>
<td>Density, g/ml</td>
<td>1.05</td>
<td>ASTM D1875</td>
</tr>
<tr>
<td>Viscosity, cP (20 rpm)</td>
<td>300 (nominal)</td>
<td>ASTM D1084</td>
</tr>
</tbody>
</table>

**CURED MECHANICAL PROPERTIES**

<table>
<thead>
<tr>
<th>Property</th>
<th>Value</th>
<th>Test Method</th>
</tr>
</thead>
<tbody>
<tr>
<td>Durometer Hardness</td>
<td>D65</td>
<td>ASTM D2240</td>
</tr>
<tr>
<td>Tensile at Break, MPa [psi]</td>
<td>16 [2,300]</td>
<td>ASTM D638</td>
</tr>
<tr>
<td>Elongation at Break, %</td>
<td>88</td>
<td>ASTM D638</td>
</tr>
<tr>
<td>Modulus of Elasticity, MPa[psi]</td>
<td>280 [40,000]</td>
<td>ASTM D638</td>
</tr>
</tbody>
</table>

**OTHER CURED PROPERTIES**

<table>
<thead>
<tr>
<th>Property</th>
<th>Value</th>
<th>Test Method</th>
</tr>
</thead>
<tbody>
<tr>
<td>Boiling Water Absorption, %</td>
<td>3.2</td>
<td>ASTM D570</td>
</tr>
<tr>
<td>Water Absorption, % (25°C, 24 hr)</td>
<td>2.0</td>
<td>ASTM D570</td>
</tr>
<tr>
<td>Linear Shrinkage, %</td>
<td>0.6</td>
<td>ASTM D2566</td>
</tr>
</tbody>
</table>

**CURING GUIDELINES**

Fixture time is defined as the time to develop a shear strength of 0.1 N/mm² [10 psi] between glass slides. Actual cure time typically is 3 to 5 times fixture time.

<table>
<thead>
<tr>
<th>Dymax Curing System (Intensity)</th>
<th>Fixture Time or Belt Speed</th>
</tr>
</thead>
<tbody>
<tr>
<td>2000-EC (50 mW/cm²)</td>
<td>2 sec</td>
</tr>
<tr>
<td>5000-EC (200 mW/cm²)</td>
<td>&lt;1 sec</td>
</tr>
<tr>
<td>BlueWave® 75 (5.0 W/cm²)</td>
<td>1 sec</td>
</tr>
<tr>
<td>BlueWave® 200 (10 W/cm²)</td>
<td>&lt;1 sec</td>
</tr>
<tr>
<td>UVCS Conveyor with one 5000-EC (200 mW/cm²)</td>
<td>&gt;8.2 m/min [&gt;27 ft/min]</td>
</tr>
<tr>
<td>UVCS Conveyor with Fusion F300S (2.5 W/cm²)</td>
<td>&gt;8.2 m/min [&gt;27 ft/min]</td>
</tr>
</tbody>
</table>

A. Intensity was measured over the UVA range (320-395 nm) using a Dymax ACCU-CAL™ 50 Radiometer.

B. Curing through light-blocking substrates may require longer cure times if they block wavelengths used for curing (320-450 nm). These fixture times/speeds are typical for curing thin films through 100% light-transmitting substrates.

C. At 53 mm [2.1 in] focal distance. Maximum speed of conveyor is 9.2 m/min [27 ft/min]. Intensity was measured over the UV range (320-395 nm) using the Dymax ACCU-CAL™ 100 Radiometer.

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OPTIMIZING PERFORMANCE AND HANDLING

1. This product cures with exposure to UV and visible light. Exposure to ambient and artificial light should be kept to a minimum before curing. Dispensing components including needles and fluid lines should be 100% light blocking, not just UV blocking.

2. All bond surfaces should be clean and free from grease, mold release, or other contaminants prior to dispensing the adhesive.

3. Cure speed is dependent upon many variables, including lamp intensity, distance from the light source, required depth of cure, bond gap, and percent light transmission of the substrate.

4. Oxygen in the atmosphere may inhibit surface cure. Surfaces exposed to air may require high-intensity (>100 mW/cm²) UV light to produce a dry surface cure. Flooding the bond area with an inert gas, such as nitrogen, can also reduce the effects of oxygen inhibition.

5. Parts should be allowed to cool after cure before testing and subjecting to any loads.

6. In rare cases, stress cracking may occur in assembled parts. Three options may be explored to eliminate this problem. One option is to heat anneal the parts to remove molded-in stresses. A second option is to open the gap between mating parts to reduce stress caused by an interference fit. The third option is to minimize the amount of time the liquid adhesive remains in contact with the substrate(s) prior to curing.

7. Light curing generally produces some heat. If necessary, cooling fans can be placed in the curing area to reduce the heating effect on components.

8. At the point of curing, an air exhaust system is recommended to dissipate any heat and vapors formed during the curing process.

DISPENSING THE ADHESIVE

This material may be dispensed with a variety of manual and automatic applicators or other equipment as required. Questions relating to dispensing and curing systems for specific applications should be referred to Dymax Application Engineering.

CLEANUP

Uncured material may be removed from dispensing components and parts with organic solvents. Cured material will be impervious to many solvents and difficult to remove. Cleanup of cured material may require mechanical methods of removal.

BIOCOMPATIBILITY

Polymerized Dymax MD® Medical Device adhesives are biocompatibility tested in accordance with ISO 10993 and/or USP Class VI. The completed tests are listed on each product data sheet. These adhesives have not been tested for prolonged or permanent implantation, and are only intended for use in short-term (<29 days) or single-use disposable-device applications. Dymax does not authorize their use in long-term implant applications.

STERILIZATION

Compatible sterilization methods include gamma irradiation and ethylene oxide. Sterilization by autoclaving may be limited to certain applications. It remains the user’s obligation to ascertain the effect of sterilization on the cured adhesive.

STORAGE AND SHELF LIFE

Store the material in a cool, dark place when not in use. Do not expose to light. This product may polymerize upon prolonged exposure to ambient and artificial light. Keep covered when not in use. This material has a 10-month shelf life from date of manufacture, unless otherwise specified, when stored between 10°C (50°F) and 35°C (90°F) in the original, unopened container.

GENERAL INFORMATION

This product is intended for industrial use only. Keep out of the reach of children. Avoid breathing vapors. Avoid contact with skin, eyes, and clothing. Wear impervious gloves. Repeated or continuous skin contact with uncured material may cause irritation. Remove material from skin with soap and water. Never use organic solvents to remove material from skin and eyes. For more information on the safe handling of this material, please refer to the Safety Data Sheet before use.

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